

Surface Mount Super Fast Rectifiers

FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Super fast recovery time for high efficiency
- Built-in strain rellef
- Moisture sensitivity level: level 1, per J-STD-020
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition







DO-214AC (SMA)

MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound, UL flammability classification rating 94V-0

Base P/N with suffix "G" on packing code - Green compound (halogen-free)

Base P/N with prefix "H" on packing code - AEC-Q101 qualified **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 1A whisker test

with prefix "H" on packing code meet JESD 201 class 2 whisker test

Polarity: Indicated by cathode band **Weight:** 0.06 g (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERSTICS (T _A =25°C unless otherwise noted)										
DADAMETED	SYMBOL	ES ES ES ES			ES	ES ES		ES ES		LINUT
PARAMETER	SYMBOL	1A	1B	1C	1D	1F	1G	1H	1J	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	150	200	300	400	500	600	V
Maximum RMS voltage	V_{RMS}	35	70	105	140	210	280	350	420	V
Maximum DC blocking voltage	V_{DC}	50	100	150	200	300	400	500	600	V
Maximum average forward rectified current	I _{F(AV)}	I _{F(AV)} 1		Α						
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	30				А				
Maximum instantaneous forward voltage (Note 1) @ 1 A	V _F	0.95		1.3		1.7		V		
Maximum reverse current @ rated VR T_J =25 $^{\circ}$ C T_J =100 $^{\circ}$ C	I _R	5 100		μA						
Maximum reverse recovery time (Note 2)	Trr	35		ns						
Typical junction capacitance (Note 3)	Cj	16 18			pF					
Typical thermal resistance	R _{eJL} R _{eJA}	35 85			°C/W					
Operating junction temperature range	TJ	- 55 to +150			οС					
Storage temperature range	T _{STG}	- 55 to +150						οС		

Note 1: Pulse test with PW=300µs, 1% duty cycle

Note 2: Reverse Recovery Test Conditions: I_F =0.5A, I_R =1.0A, I_{RR} =0.25A

Note 3: Measured at 1 MHz and Applied V_R =4.0 Volts



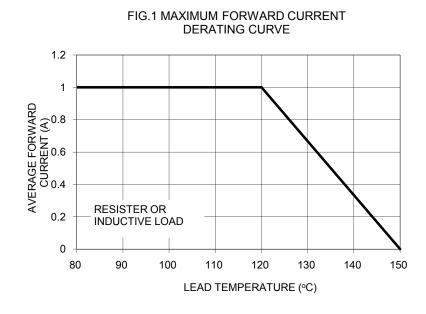
ORDERING INFORMATION						
PART NO.	AEC-Q101	PACKING	GREEN COMPOUND	PACKAGE	PACKING	
	QUALIFIED	CODE	CODE			
		R3		SMA	1,800 / 7" Plastic reel	
		R2		SMA	7,500 / 13" Paper reel	
ES1x (Note 1) Prefix "H"	M2		SMA	7,500 / 13" Plastic reel		
	FIGUX II	F3	Suffix "G"	Folded SMA	1,800 / 7" Plastic reel	
		F2		Folded SMA	7,500 / 13" Paper reel	
		F4		Folded SMA	7,500 / 13" Plastic reel	
	N/A	E3		Clip SMA	1,800 / 7" Plastic reel	
		E2		Clip SMA	7,500 / 13" Plastic reel	

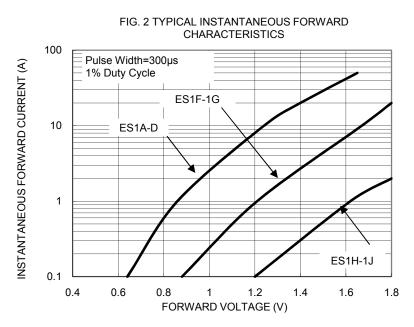
Note 1: "x" defines voltage from 50V (ES1A) to 600V (ES1J)

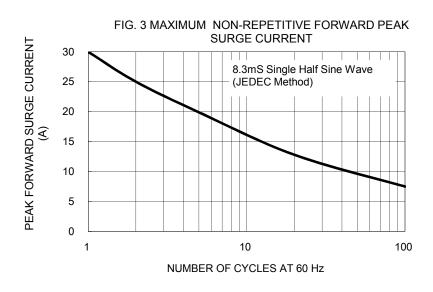
EXAMPLE						
PREFERRED P/N	PART NO.	AEC-Q101 QUALIFIED	PACKING CODE	GREEN COMPOUND CODE	DESCRIPTION	
ES1J R3	ES1J		R3			
ES1J R3G	ES1J		R3	G	Green compound	
ES1JHR3	ES1J	Н	R3		AEC-Q101 qualified	

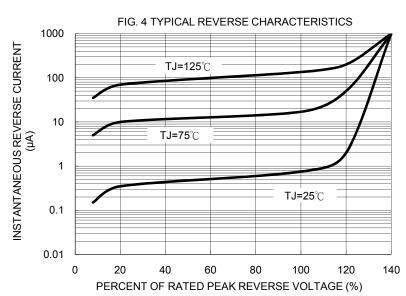
RATINGS AND CHARACTERISTICS CURVES

(TA=25°C unless otherwise noted)









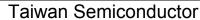




FIG. 5 TYPICAL JUNCTION CAPACITANCE

100

ES1F-J

F=1.0MHz

Vsig=50mVp-p

1

0.1

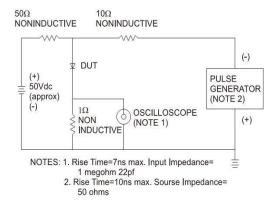
1

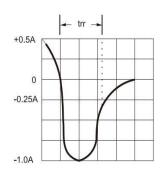
10

100

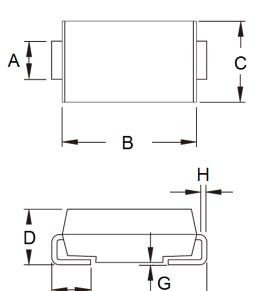
REVERSE VOLTAGE (V)

FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM





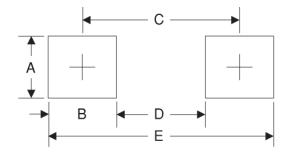
PACKAGE OUTLINE DIMENSIONS



DIM.	Unit	(mm)	Unit (inch)			
Dilvi.	Min Max		Min	Max		
Α	1.27	1.58	0.050	0.062		
В	4.06	4.60	0.160	0.181		
С	2.29	2.83	0.090	0.111		
D	1.99	2.50	0.078	0.098		
Е	0.90	1.41	0.035	0.056		
F	4.95	5.33	0.195	0.210		
G	0.10	0.20	0.004	0.008		
Н	0.15	0.31	0.006	0.012		

SUGGESTED PAD LAYOUT

Ε



Symbol	Unit (mm)	Unit (inch)
Α	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
Ē	5.45	0.215

MARKING DIAGRAM



P/N = Specific Device Code G = Green Compound

YW = Date Code

F = Factory Code





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Taiwan Semiconductor:

ES1G R3 ES1J F3 ES1F R3 ES1G E3 ES1D F3 ES1B F3 ES1J M2G ES1D M2G ES1D R2 ES1JHF2

ES1DHR3 ES1DHR2 ES1D F3G ES1J F3G ES1DHF2 ES1JHR3 ES1JHR2 ES1JHF3 ES1J R2G ES1DHF3

ES1J R3G ES1B F3G ES1BHR3 ES1BHR2 ES1BHF2 ES1G R2G ES1D R3G ES1GHR3 ES1G F3G ES1B R2G

ES1BHF3 ES1G R3G ES1GHF2 ES1GHF3 ES1GHR2 ES1B R3G ES1D R2G ES1B E3 ES1D E3 ES1J E2

ES1J E3 ES1G F3 ES1FHR3 ES1CHR3 ES1HHR3 ES1AHR3